

## 14.1 SEMIDRIVER<sup>®</sup>-Accessories (for SEMIDRIVER<sup>®</sup> SKHI 21 and SKHI 22)

## Printed Circuit Board (PCB) SKPC 2006 <sup>1)</sup>

Recommended piece parts list			
Part No. <sup>1)</sup>	Function <sup>2)</sup>	Designation	Recommended Values <sup>2)</sup>
C1	V <sub>s</sub> <sup>4)</sup>	Radial Electrol. cap.	10...47 µF / 35 V
C2	C <sub>CEBOT</sub>	Polystyrene cap.	0,33 nF > 25 V
C3	C <sub>CE TOP</sub>	Polystyrene cap.	0,33 nF > 25 V
R1	R <sub>TD1</sub>	Resistor <sup>2)</sup>	0 - 100 kΩ / 0,25 W
R2	R <sub>TD2</sub>	Resistor <sup>2)</sup>	0 - 100 kΩ / 0,25 W
R3	R <sub>CE2BOT</sub>	Resistor <sup>2)</sup>	typ. 24 kΩ / 0,6 W
R4	R <sub>Gon2BOT</sub>	Resistor <sup>3)</sup>	3,3 ... 100 Ω
R5	R <sub>Goff2BOT</sub>	Resistor <sup>3)</sup>	3,3 ... 100 Ω
R6	R <sub>Goff1TOP</sub>	Resistor <sup>3)</sup>	3,3 ... 100 Ω
R7	R <sub>Gon1TOP</sub>	Resistor <sup>3)</sup>	3,3 ... 100 Ω
R8	R <sub>CE1TOP</sub>	Resistor <sup>2)</sup>	typ. 24 kΩ / 0,6 W
Conn 1	input	1 x MOLEX 7395 <sup>6)</sup> -(5 way - 2,54 pitch)	
Conn 2...5	out par.	for cables joining to slave boards	
Conn 6 - 4	out	4 x MOLEX 90030 - 1001 <sup>7)</sup> (for 2,8 x 0,5)	
TP1	V <sub>CE</sub> Top +	Wire connection to + V <sub>ERAIL</sub>	
TP2	V <sub>CE</sub> mon E1	} 1 jumper <sup>5)</sup> to connect BOTT.C2 to TOP emitter (E1)	
TP3	V <sub>CE</sub> mon C2		

### Features

- blank PCB
- glass fibre epoxy
- without piece parts
- ready to fit parts for wave soldering
- output connectors positioned for direct push-on to SEMI-TRANS-3
- 3 hole fixing

- <sup>1)</sup> SKPC 2006 normally should be completed by the customer, but it can be made available with parts fitted, on mutual agreement on request.
- <sup>2)</sup> See datasheet SKHI 21, SKHI 22 page B14 – 21
- <sup>3)</sup> Values to be chosen as per datasheet of SKHI 22 and of the device to be driven.
- <sup>4)</sup> For decoupling the power supply at input
- <sup>5)</sup> Must be connected (C2 - E1) for V<sub>CE</sub> monitoring
- <sup>6)</sup> Right Angle Friction LOCK mates with MOLEX 6471, 7720S, 2695

<sup>7)</sup> MOLEX Mini T Terminal with solder post, loose-form  
(Chain form: 90030-0001)

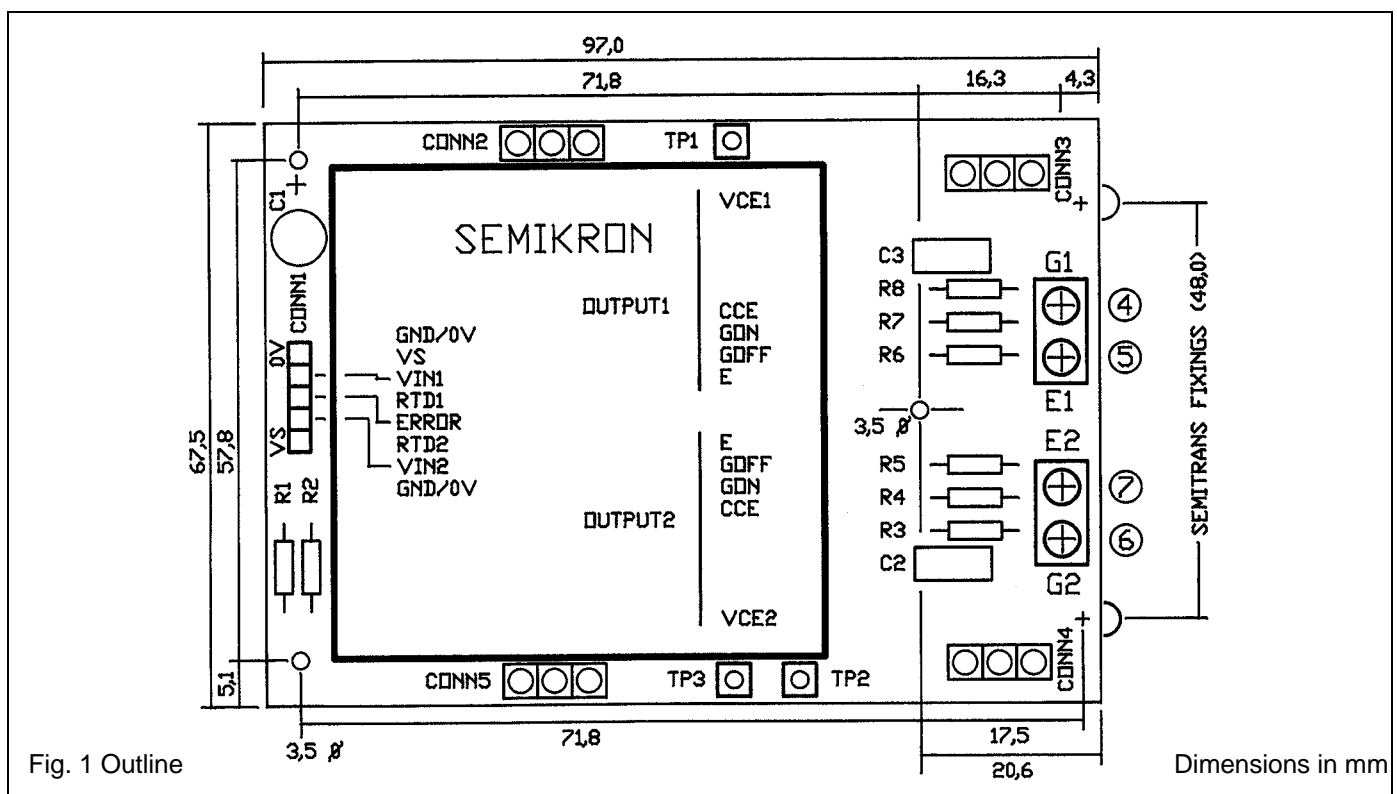


Fig. 1 Outline

Dimensions in mm

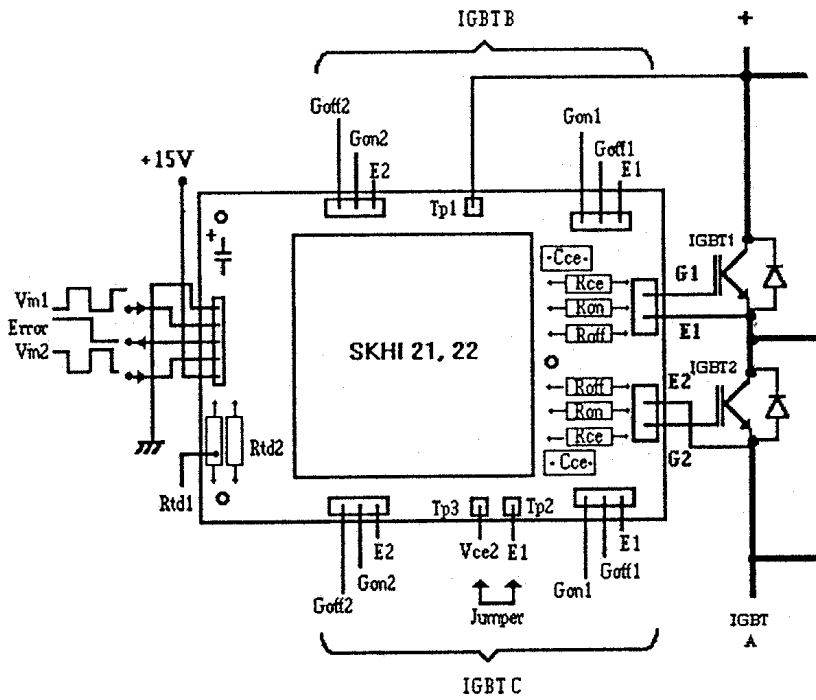


Fig. 2 Layout and connection to drive 1 IGBT DUAL module

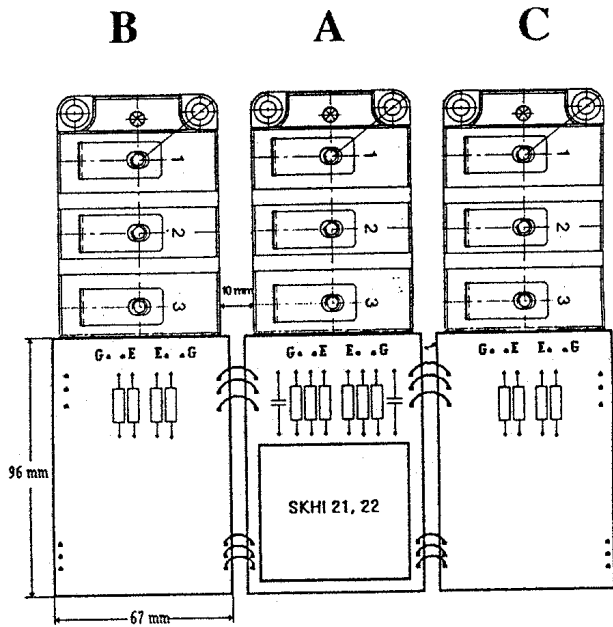


Fig. 3 One SKPC 2006 driving 3 DUAL modules SKM 200 GB 123 D via 2 slave boards

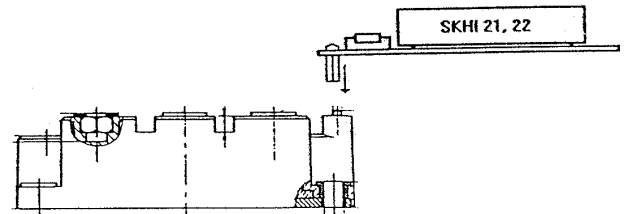


Fig. 4 SKPC 2006 fitting directly to the gate pins of SEMITRANS 3 (For SEMITRANS 2 use soft wiring to the gate connectors)